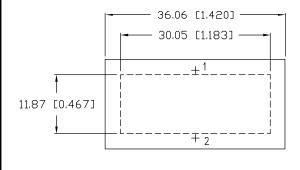
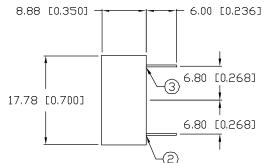
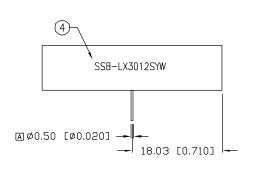
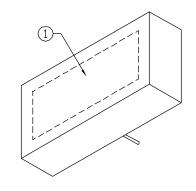
UNCONTROLLED DOCUMENT







■ PIN OUT



PART NUMBER SSB-LX3012SYW

REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
Α	E.C.N. #10922.	10.29.02
В	E.C.N. #11091.	2.6.04

ELECTRO-OPTICAL CHA	ARACTERISTICS TA=25°C		$I_f = 40 \text{mA}$		
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		590		nm	
FORWARD VOLTAGE		3.8	4.2	۷f	
REVERSE VOLTAGE	5.0			V_r	1 _r =100µA
AXIAL INTENSITY		880		cd/m²	$I_f = 40mA$
VIEWING ANGLE		160		2x theta	
EMITTED COLOR:	YELLOW/AMBER				
EPOXY LENS FINISH:	MILKY	WHITE DIFFUSED			

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	40	mA
POWER DISSIPATION	150	mW
DERATE FROM 25°C	-1.0	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	•C
SOLDERING TEMP.	+ 260	° C
2.0mm FROM BODY		3 SEC. MAX
1. 1. 10. 0		

* t<10µS

NOTES:



- 2. STAMPED "K" ON PCB TO INDICATE CATHODE.
- 3. STAMPED "A" ON PCB TO INDICATE ANODE.
- 4. LUMEX PIN, DATE CODE, AND BIN CODE ARE STAMPED ON SIDE OF PART.
- 5. LED CHIPS ARE SORTED FOR UNIFORM INTENSITY AND COLOR.
- 6. PROTECTIVE FILM IS MARKED WITH A BLACK DOT

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION MAX.= +0.00 |

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.000), LEAD SIZE=±0.05 (±0.000

REV. PART NUMBER SSB-LX3012SYW

30mm x 12mm RECTANGULAR LIGHT BAR, 590nm YELLOW LED CHIPS, MILKY WHITE DIFFUSED.

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RELIABILITY NOTE OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



290 E. HELEN ROAD PALATINE, IL 60067-6976 PHONE: +1.847.359.2790 US WEB: www.lumex.com TW WEB: www.lumex.com.tw

CHECKED BY: APPROVED BY: DATE: DRAWN BY: 9.17.02 PAGE: 1 OF 1 SCALE: N/A